





6-Pin DIP Zero-Cross Optoisolators Triac Driver Output (250 Volts Peak)

The MOC3031, MOC3032 and MOC3033 devices consist of gallium arsenide infrared emitting diodes optically coupled to a monolithic silicon detector performing the function of a Zero Voltage crossing bilateral triac driver.

They are designed for use with a triac in the interface of logic systems to equipment powered from 115 Vac lines, such as teletypewriters, CRTs, printers, motors, solenoids and consumer appliances, etc.

- Simplifies Logic Control of 115 Vac Power
- Zero Voltage Crossing
- dv/dt of 2000 V/μs Typical, 1000 V/μs Guaranteed
- To order devices that are tested and marked per VDE 0884 requirements, the suffix "V" must be included at end of part number. VDE 0884 is a test option.

Recommended for 115 Vac(rms) Applications:

- Solenoid/Valve Controls
- Lighting Controls
- Static Power Switches
- AC Motor Drives

- Temperature Controls
- · E.M. Contactors
- AC Motor Starters
- Solid State Relays

 T_A

T_{stg}

-40 to +85

-40 to +150

°C

°C

°C

MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

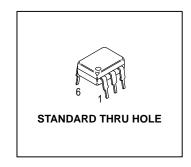
Rating	Symbol	Value	Unit	
NFRARED LED				
Reverse Voltage	VR	3	Volts	
Forward Current — Continuous	lF	60	mA	
Total Power Dissipation @ T _A = 25°C Negligible Power in Output Driver Derate above 25°C	PD	120 1.41	mW mW/°C	
OUTPUT DRIVER				
Off-State Output Terminal Voltage	V _{DRM}	250	Volts	
Peak Repetitive Surge Current (PW = 100 μs, 120 pps)	ITSM	1	Α	
Total Power Dissipation @ T _A = 25°C Derate above 25°C	PD	150 1.76	mW mW/°C	
TOTAL DEVICE	-			
Isolation Surge Voltage(1) (Peak ac Voltage, 60 Hz, 1 Second Duration)	V _{ISO} 7500		Vac(pk)	
Total Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	250 2.94	mW mW/°C	
Junction Temperature Range	TJ	-40 to +100	°C	

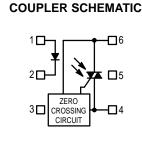
Ambient Operating Temperature Range

Storage Temperature Range

Soldering Temperature (10 s)

MOC3031 MOC3032 MOC3033





- 1. ANODE
- 2. CATHODE
- 3. NC
- 4. MAIN TERMINAL
- 5. SUBSTRATE DO NOT CONNECT
- 6. MAIN TERMINAL

^{1.} Isolation surge voltage, V_{ISO}, is an internal device dielectric breakdown rating. For this test, Pins 1 and 2 are common, and Pins 4, 5 and 6 are common.

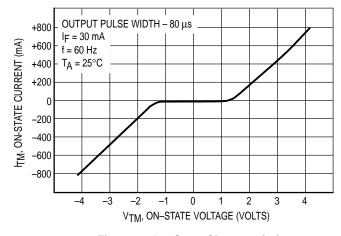


ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
INPUT LED	•	•	•	•	•
Reverse Leakage Current (V _R = 3 V)	IR	_	0.05	100	μА
Forward Voltage (IF = 30 mA)	VF	_	1.3	1.5	Volts
OUTPUT DETECTOR (I _F = 0 unless otherwise noted)	•		•	•	•
Leakage with LED Off, Either Direction (Rated V _{DRM} ⁽¹⁾)	I _{DRM1}	_	10	100	nA
Peak On–State Voltage, Either Direction (I _{TM} = 100 mA Peak)	VTM	_	1.8	3	Volts
Critical Rate of Rise of Off–State Voltage	dv/dt	1000	2000	_	V/μs
COUPLED		•	•	•	•
LED Trigger Current, Current Required to Latch Output (Main Terminal Voltage = 3 V ⁽²⁾) MOC3031 MOC3032 MOC3033	lFT	_ _ _	_ _ _	15 10 5	mA
Holding Current, Either Direction	lн	_	250	_	μА
Isolation Voltage (f = 60 Hz, t = 1 sec)	V _{ISO}	7500	_	_	Vac(pk)
ZERO CROSSING	•		•	•	•
Inhibit Voltage (IF = Rated IFT, MT1-MT2 Voltage above which device will not trigger.)	VIH	_	5	20	Volts
Leakage in Inhibited State (IF = Rated IFT, Rated VDRM, Off State)	I _{DRM2}		_	500	μА

- 1. Test voltage must be applied within dv/dt rating.
- 2. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT}. Therefore, recommended operating I_F lies between max I_{FT} (15 mA for MOC3031, 10 mA for MOC3032, 5 mA for MOC3033) and absolute max I_F (60 mA).

TYPICAL ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$





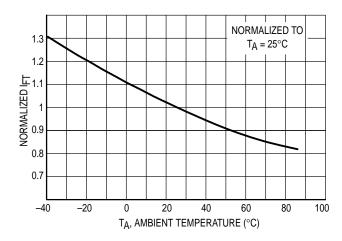


Figure 2. Trigger Current versus Temperature



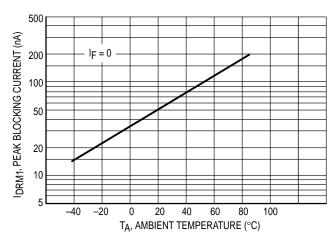


Figure 3. I_{DRM1}, Peak Blocking Current versus Temperature

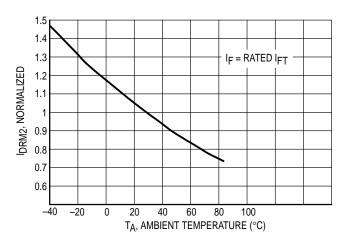


Figure 4. I_{DRM2}, Leakage in Inhibit State versus Temperature

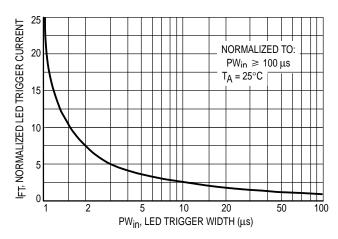
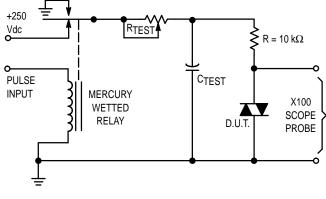


Figure 5. LED Current Required to Trigger versus LED Pulse Width



- 1. The mercury wetted relay provides a high speed repeated pulse to the D.U.T.
- 100x scope probes are used, to allow high speeds and voltages.
- 3. The worst–case condition for static dv/dt is established by triggering the D.U.T. with a normal LED input current, then removing the current. The variable RTEST allows the dv/dt to be gradually increased until the D.U.T. continues to trigger in response to the applied voltage pulse, even after the LED current has been removed. The dv/dt is then decreased until the D.U.T. stops triggering. TRC is measured at this point and recorded.

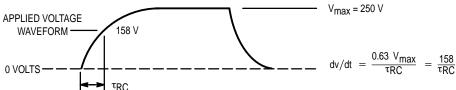
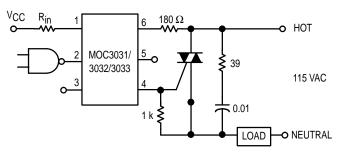


Figure 6. Static dv/dt Test Circuit

MOC3031, MOC3032, MOC3033



* For highly inductive loads (power factor < 0.5), change this value to 360 ohms.

Typical circuit for use when hot line switching is required. In this circuit the "hot" side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or hot line.

 $R_{\mbox{\scriptsize in}}$ is calculated so that IF is equal to the rated IFT of the part, 5 mA for the MOC3033, 10 mA for the MOC3032, or 15 mA for the MOC3031. The 39 ohm resistor and 0.01 μF capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load used.

Figure 7. Hot-Line Switching Application Circuit

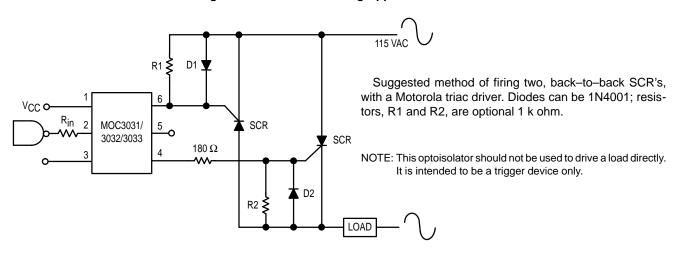
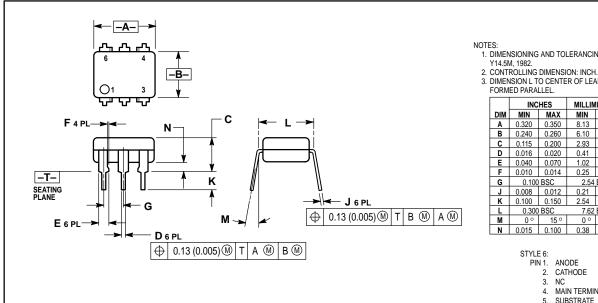


Figure 8. Inverse-Parallel SCR Driver Circuit



PACKAGE DIMENSIONS



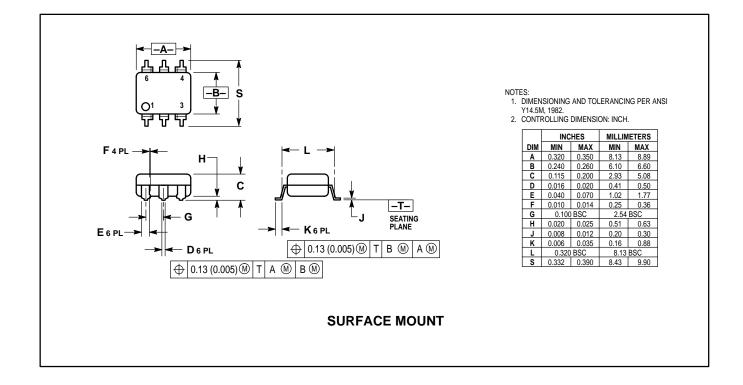
- DIMENSIONING AND TOLERANCING PER ANSI
- DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.320	0.350	8.13	8.89	
В	0.240	0.260	6.10	6.60	
С	0.115	0.200	2.93	5.08	
D	0.016	0.020	0.41	0.50	
Е	0.040	0.070	1.02	1.77	
F	0.010	0.014	0.25	0.36	
G	0.100	BSC	2.54 BSC		
J	0.008	0.012	0.21	0.30	
K	0.100	0.150	2.54	3.81	
L	0.300	BSC	7.62 BSC		
M	0 °	15°	0 °	15°	
N	0.015	0.100	0.38	2.54	

- PIN 1. ANODE
 - CATHODE

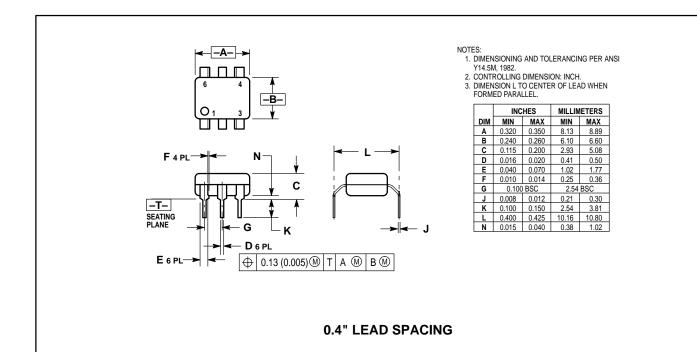
 - NC
 MAIN TERMINAL
 - SUBSTRATE
 - MAIN TERMINAL

THRU HOLE





MOC3031, MOC3032, MOC3033





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